

# EUROPEAN PATENT OFFICE

## Patent Abstracts of Japan

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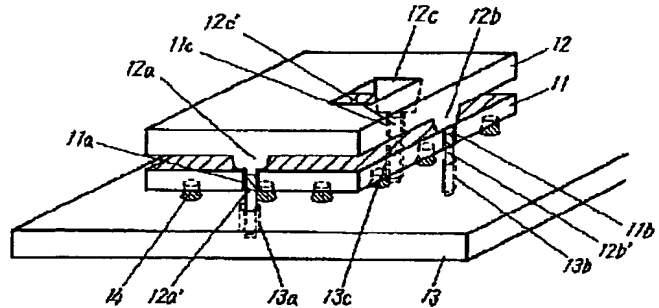
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TITLE : MODULE PART



**ABSTRACT :** PROBLEM TO BE SOLVED: To provide a module part, wherein sufficient ground connection is possible between a module part and a mother board, related to a module part used for a high-frequency part of a radio communication device.

**SOLUTION:** When a module board 11 is mounted on a motherboard 13, second projections 12a', 12b', and 12c' provided on a shield case 12 are inserted in through-holes 13a, 13b, and 13c connected electrically to a ground of the motherboard 13 for electrical connection, thus a firmer and surer ground connection is established.

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